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Yun et al.

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(54) **RADIATOR FOR A GRAPHICS CARD CHIPSET**

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(*) Notice: This patent is subject to a terminal disclaimer.

(**) Term: **14 Years**

(21) Appl. No.: **29/261,496**

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(30) **Foreign Application Priority Data**

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(51) **LOC (8) Cl.** **13-03**

(52) **U.S. Cl.** **D13/179**

(58) **Field of Classification Search** D13/179;
165/80.3, 104.33, 151, 122, 185; 257/706,
257/707, 718-722; 361/687, 695, 697, 700,
361/702, 704, 709, 710, 711, 719

See application file for complete search history.

(56) **References Cited**

U.S. PATENT DOCUMENTS

D426,196 S * 6/2000 Lee D13/179

D426,814 S * 6/2000 Lee D13/179
D458,232 S * 6/2002 Lee D13/179
6,883,592 B2 * 4/2005 Lee 165/80.3
2001/0010264 A1 * 8/2001 Kuo 165/185

* cited by examiner

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(57) **CLAIM**

The ornamental design for radiator for a graphics card chipset, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a radiator for a graphics card chipset in accordance with the new design;

FIG. 2 is a front elevational view thereof;

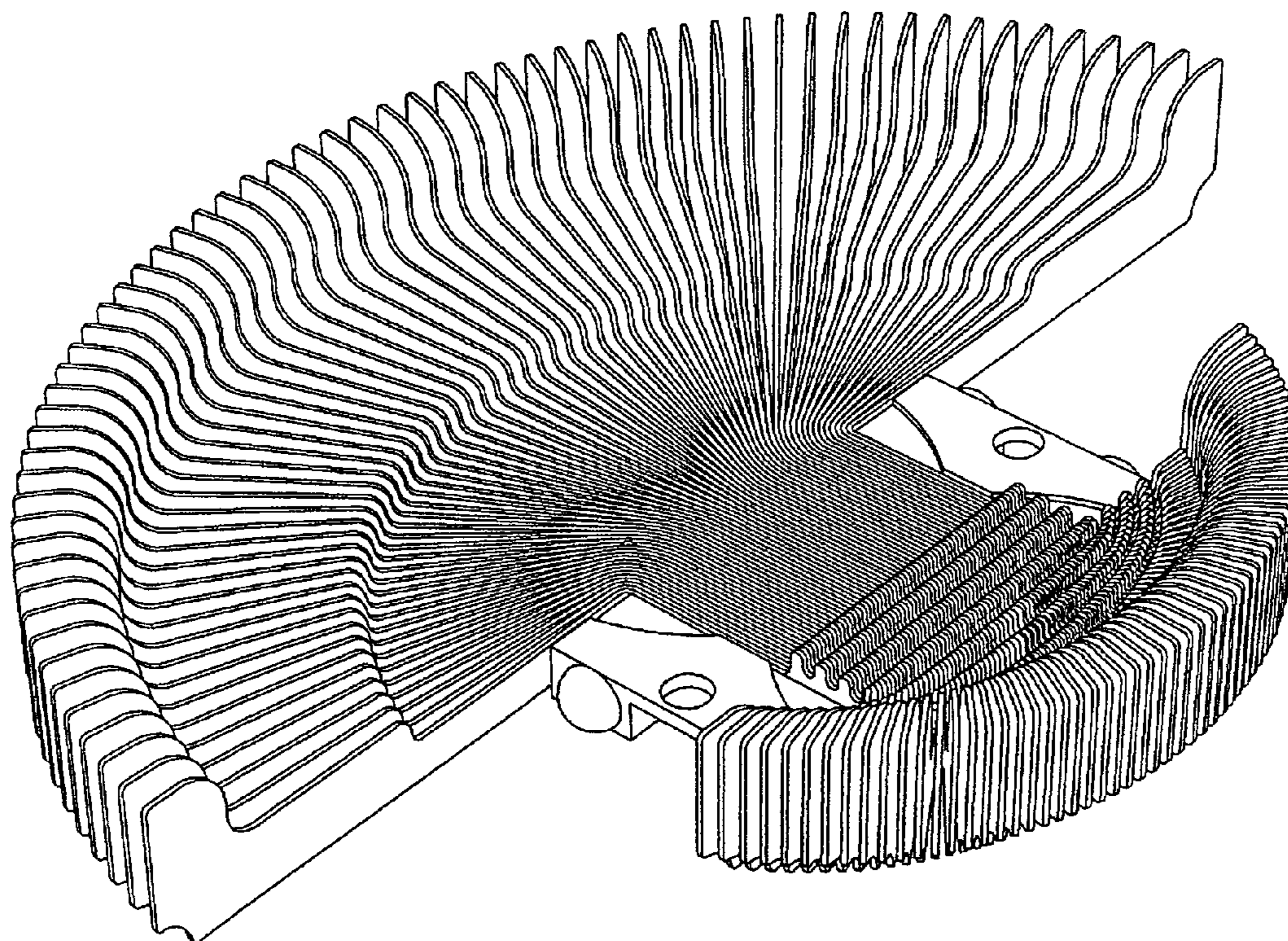
FIG. 3 is a rear elevational view thereof;

FIG. 4 is a left side elevational view thereof, the right side elevational view being a mirror image thereof;

FIG. 5 is a top plan view thereof; and,

FIG. 6 is a bottom plan view thereof.

1 Claim, 5 Drawing Sheets



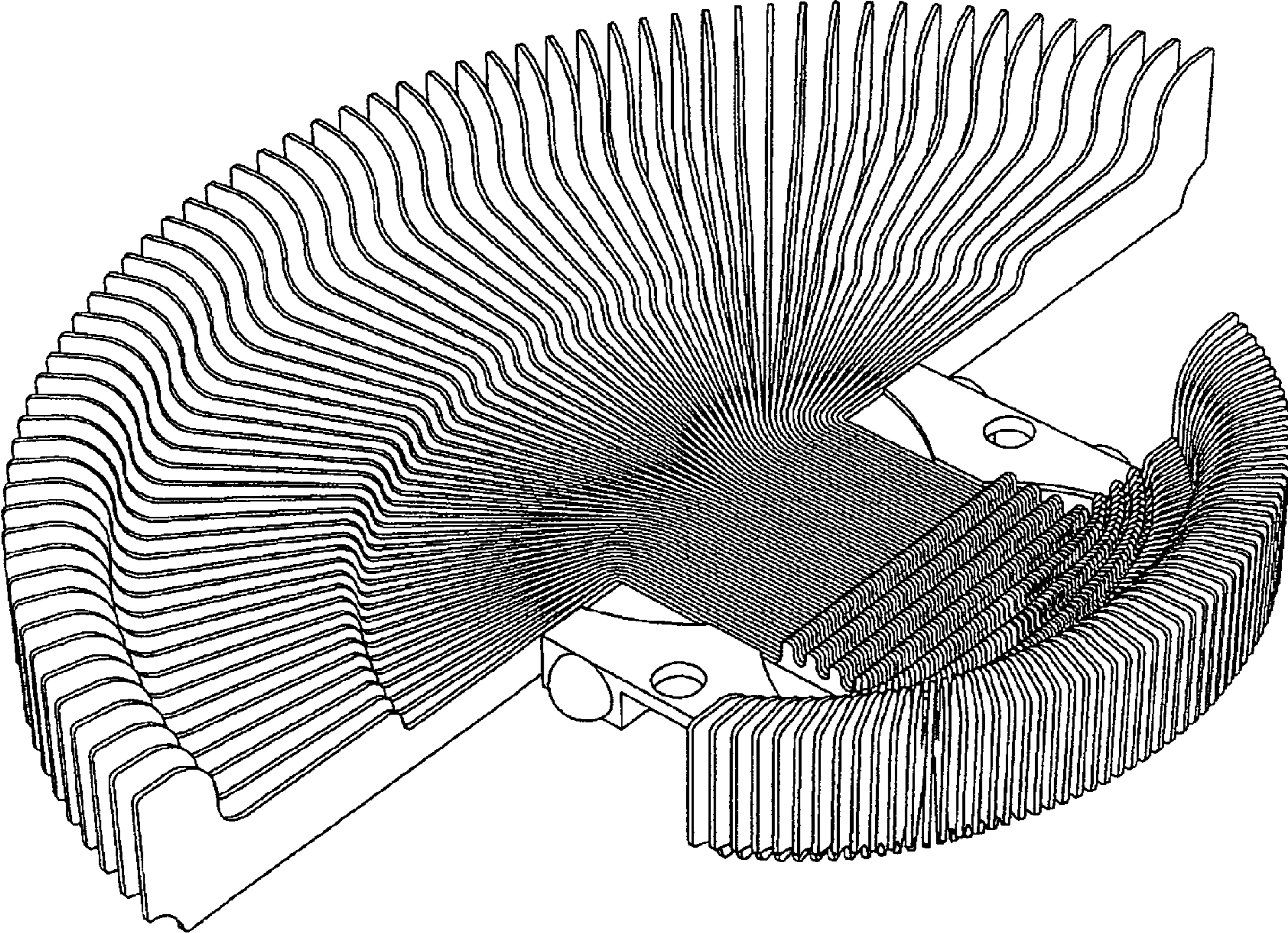


FIG. 1

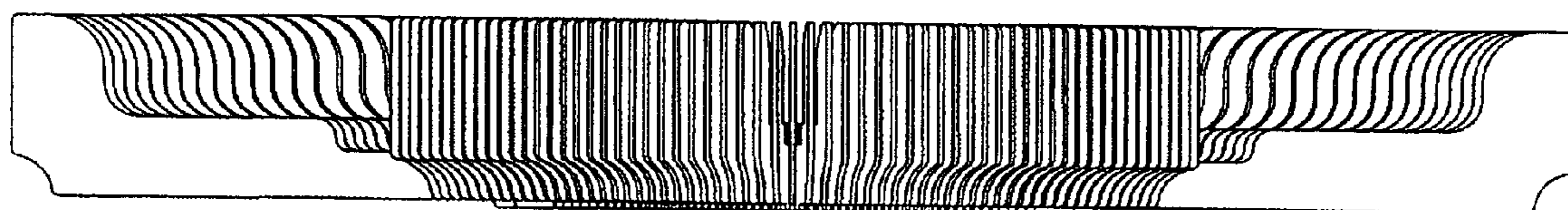


FIG. 2

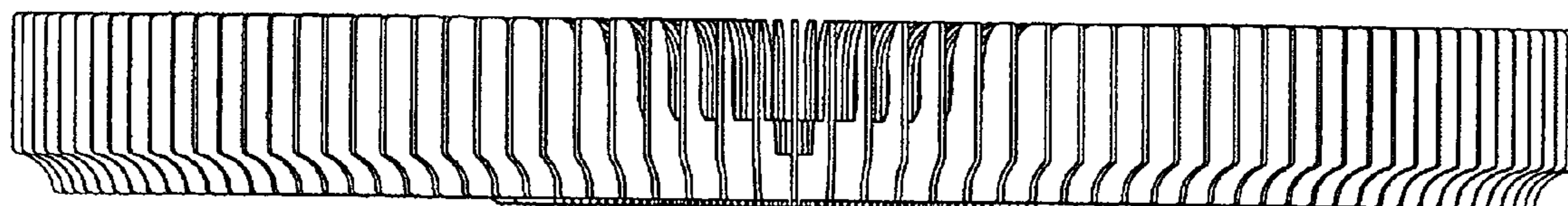


FIG. 3

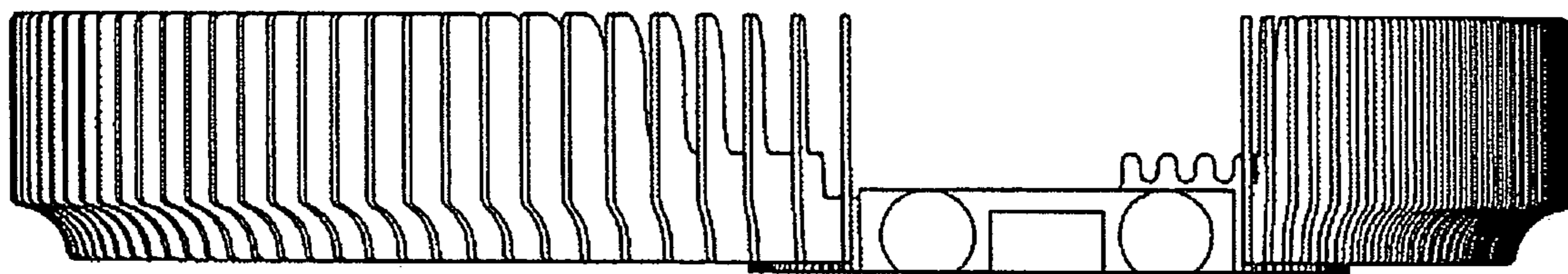


FIG. 4

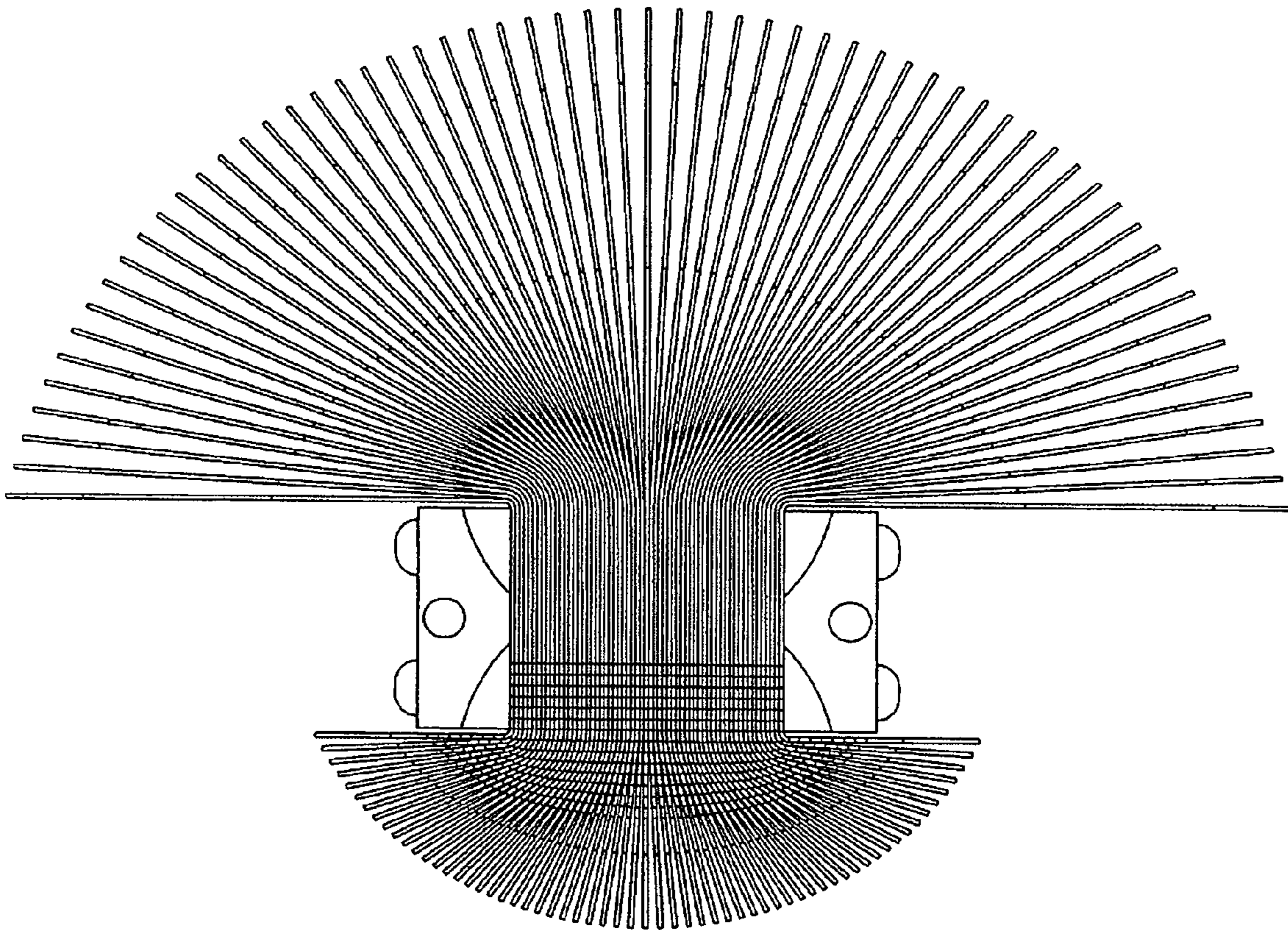


FIG. 5

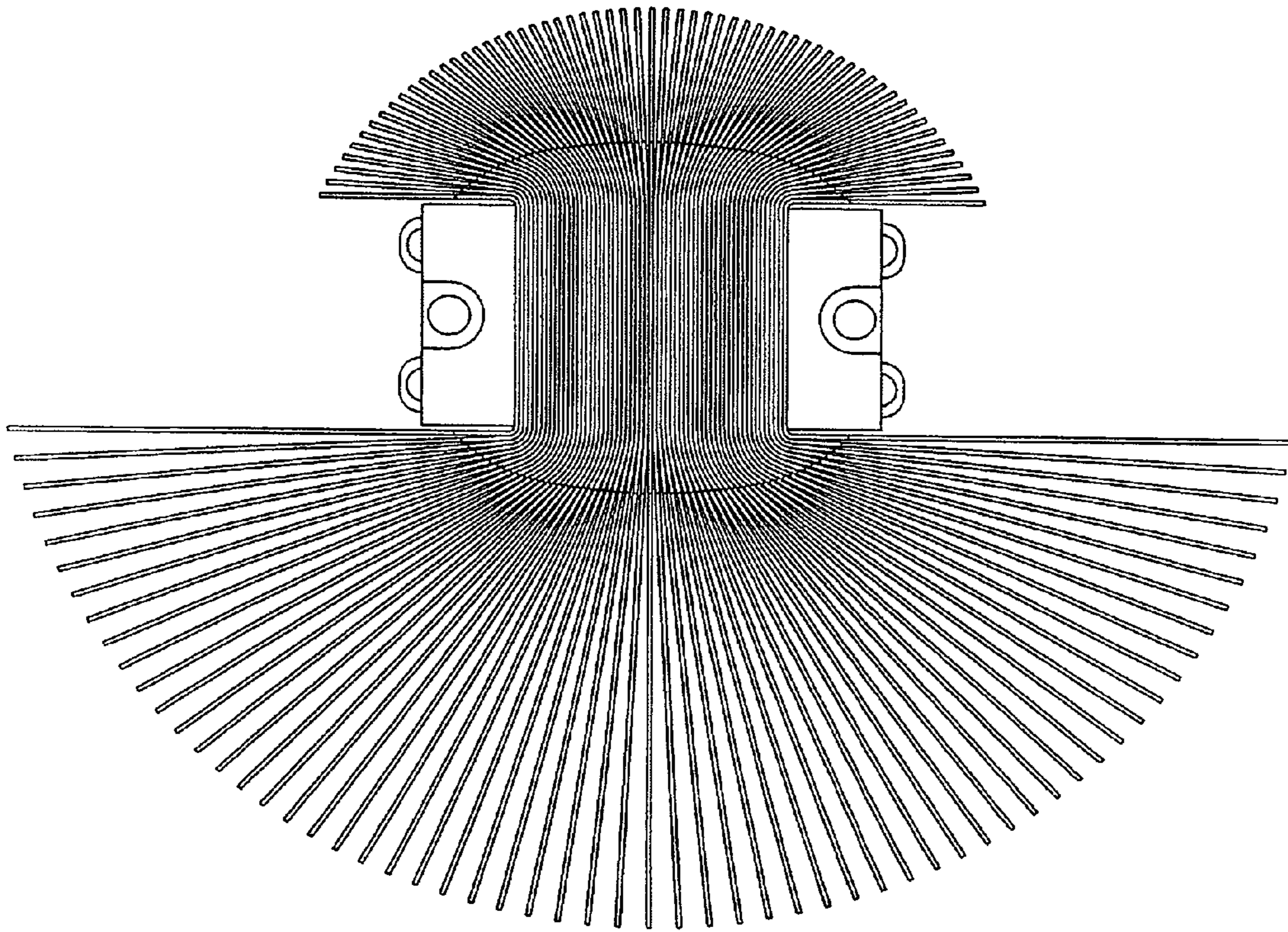


FIG. 6